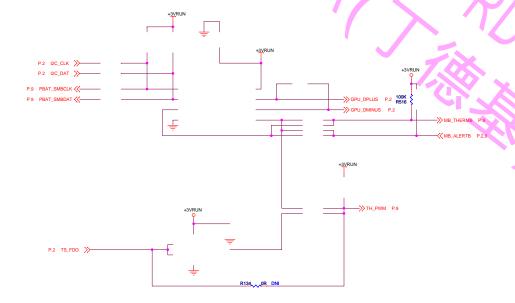




## THERMAL SENSOR AND PWM OUTPUT



## RECOMMENDED SETTINGS **CONFIGURATION STRAPS** DE DO NOT INSTALL RESISTOR 1 = INSTALL 10K RESISTOR X = DESIGN DEPENDANT NA = NOT APPLICABLE ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOS ARE USED, THEY MUST NOT CONFLICT DURING RESET DESCRIPTION OF DEFAULT SETTINGS TX\_PWRS\_ENB GPI00 PCIE FULL TX OUTPUT SWING TX\_DEEMPH\_EN GPIO1 PCIE TRANSMITTER DE-EMPHASIS ENABLED BIF GEN2 EN A GPIO2 PCIE GNE2 ENABLED BIF\_CLK\_PM\_EN BIF\_CLK\_PM\_EN GPIO8 BIF\_VGA DIS BIF\_RX\_PLL\_CALIB\_BP GPIO9 GPIO21 BIOS\_ROM\_EN ENABLE EXTERNAL BIOS ROM ROMIDCFG(2:0) GPIO[13:11] SERIAL ROM TYPE OR MEMORY APERTURE SIZE SELECT VIP\_DEVICE\_STRAP\_ENA V2SYNC IGNORE VIP DEVICE STRAPS SMS\_EN\_HARD CCBYPASS AUD[1] AUD[0] MEMORY CINFIG HYNIX SAMSUNG H2SYNC GENERICC HSYNC VSYNC [GPIO6,GPIO16] built-in HDMI connector Audio functiuon present

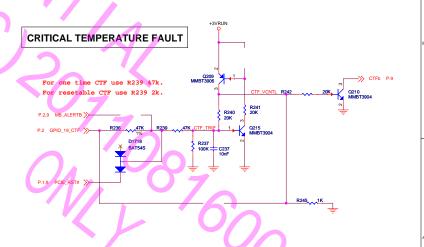
## AMD RESERVED CONFIGURATION STRAPS

ALLOW FOR PULLUP PADS FOR THESE STRAPS AND IF THESE GPIOS ARE USED, THEY MUST NOT CONFLICT DURING RESET

H2SYNC GENERICC

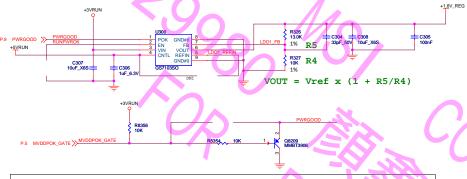
PULLUP PADS ARE NOT REQUIRED FOR THESE STRAPS BUT IF THESE GPIOS ARE USED, THEY MUST NOT CONFLICT DURING RESET

GPIO\_28\_TDO GPIO21\_BB\_EN

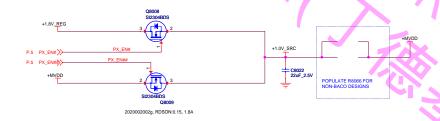


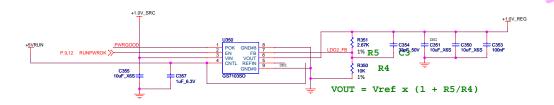


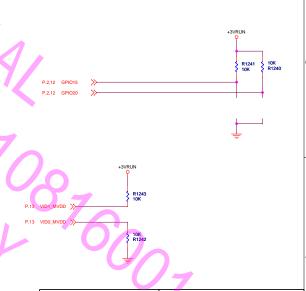
LDO #1: Vin = 3.00V to 3.60V (3.3V +/- 9%) Vout = +1.8V +/- 2%; lout = 0.8A (TBV) RMS MAX PCB: 50 to 70mm sq. copper area for cooling



LDO #2: Vin = +1.32V to 1.84VMAX Vout = +1.0V +/- 2% lout = 1.7A (TBV) RMS MAX PCB: 50 to 70mm sq. copper area for cooling







RH Onega/Caspian M2 package MXM3.0 GD5

**AMD** 

No. 102-C28822-00

Tuesday, May 03, 2011

